L	Hits	Search Text	DB	Time stamp
Number				Time Stamp
229	189	((polymer or deposit or residue ) and	USPAT;	2002/10/24
		(((plasma or gas\$2) near10 puls\$5) and	EPO; JPO;	13:11
		semiconductor) ) and 438/\$.ccls.	IBM TDB	
230	875	((polymer or deposit or residue ) and	USPAT;	2002/10/24
		((plasma or gas\$2) near10 puls\$5) and	EPO; JPO;	13:17
		semiconductor)	IBM TDB	
232	697	( , , Land or debests of residue ) and	USPAT;	2002/10/24
		((plasma or gas\$2) near10 puls\$5) and	EPO; JPO;	15:32
		semiconductor) ) and (contact or	IBM TDB	
		openings)	_	
235	19	( cite of or of office of card) same	USPAT;	2002/10/24
		puls\$5	EPO; JPO;	15:32
	0.7		IBM_TDB	
	27	Parsto Parsto Same (Porymer	USPAT;	2002/10/24
		or deposit)	EPO; JPO;	15:28
	0.1	/	IBM_TDB	
237	21	(CHF3 or CF4 or CH2F2 or C4F8) and puls\$5	USPAT;	2002/10/24
		and (contact or openings or via) and	EPO; JPO;	15:18
	101	polymer	IBM_TDB	
240	121	fluorocarbons same puls\$5	USPAT;	2002/10/24
			EPO; JPO;	15:28
241	108	(CHE) CHA CHOPO	IBM_TDB	
241	108	(CHF3 or CF4 or CH2F2 or C4F8) and puls\$5	USPAT;	2002/10/24
		and (contact or openings or via)	EPO; JPO;	16:04
242	321	(CUE) on CEA on CUORD on CARD	IBM_TDB	
242	321	(CHF3 or CF4 or CH2F2 or C4F8) and	USPAT;	2002/10/24
		(contact or openings or via) and (polymer	EPO; JPO;	16:07
		or residue or deposit)	IBM_TDB	